

### Product Change Notification / GBNG-06JPSY308

## Date:

08-Feb-2021

## **Product Category:**

Switching Regulators

### PCN Type:

Manufacturing Change

### **Notification Subject:**

CCB 4204 Final Notice: Qualification of Microchip Technology Tempe – Fab 2 (TMGR) as a new fabrication site for selected Microsemi SG1524BN, SG2524Bxx and SG3524Bxx device families available in 16L PDIP (.300in) and 16L SOIC (.300in) packages.

## Affected CPNs:

GBNG-06JPSY308\_Affected\_CPN\_02082021.pdf GBNG-06JPSY308\_Affected\_CPN\_02082021.csv

## **Notification Text:**

PCN Status: Final notification

PCN Type: Manufacturing Change

Microchip Parts Affected: Please open one of the icons found in the Affected CPNs section above.

NOTE: For your convenience Microchip includes identical files in two formats (.pdf and .xls).

**Description of Change:** Qualification of Microchip Technology Tempe – Fab 2 (TMGR) as a new fabrication site for selected Microsemi SG1524BN, SG2524Bxx and SG3524Bxx device families available in 16L PDIP (.300in) and 16L SOIC (.300in) packages.

# Pre Change:

Fabricated at Microsemi Garden Grove Bipolar Linear Fab Line – Fab1

Post Change:

#### Fabricated at Microchip Technology Tempe – Fab 2

#### Pre and Post Change Summary:

	Pre Change	Post Change				
Fabrication Site	Microsemi Garden Grove Bipolar Linear Fab Line Fab1 (MGGV)	Microchip Technology Tempe – Fab 2 (TMGR)				
Wafer diameter	4 inches	8 inches				
Die size	No change	No change				
Quality certification	AS9100/ISO9001	ISO9001/TS16949 or IATF16949				

#### Impacts to Data Sheet: None

#### Change Impact: None

**Reason for Change:** To improve manufacturability and on-time delivery performance by qualifying Microchip Technology Tempe – Fab 2 (TMGR) as a new fabrication site.

#### Change Implementation Status: In Progress

#### Estimated First Ship Date:

March 12, 2021 (date code: 2111)

NOTE: Please be advised that after the estimated first ship date customers may receive pre and post change parts.

#### Time Table Summary:

	April 2020				>	February 2021			March 2021						
Workweek	14	15	16	17	18		06	07	08	09	10	11	12	13	14
Initial PCN Issue Date			Х												
Qual Report Availability								Х							
Final PCN Issue Date								Х							
Estimated Implementation Date												Х			

#### Method to Identify Change: Traceability code

#### Qualification Report:

Please open the attachments included with this PCN labeled as PCN\_#\_Qual\_Report.

Revision History: April 14, 2020: Issued initial notification.

November 03, 2020: Re-issued initial notification to update the qualification plan.

**February 08**, **2021**: Issued final notification. Attached is the qualification report and added the estimated first ship date by March 12, 2021.

The change described in this PCN does not alter Microchip's current regulatory compliance regarding the material content of the applicable products.

## Attachments:

### PCN\_GBNG-06JPSY308\_Qual\_Report.pdf

Please contact your local Microchip sales office with questions or concerns regarding this notification.

### **Terms and Conditions:**

If you wish to <u>receive Microchip PCNs via email</u> please register for our PCN email service at our PCN home page select register then fill in the required fields. You will find instructions about registering for Microchips PCN email service in the PCN FAQ section.

If you wish to <u>change your PCN profile</u>, <u>including opt out</u>, please go to the <u>PCN home page</u> select login and sign into your myMicrochip account. Select a profile option from the left navigation bar and make the applicable selections. GBNG-06JPSY308 - CCB 4204 Final Notice: Qualification of Microchip Technology Tempe – Fab 2 (TMGR) as a new fabrication site for selected Microsemi SG1524BN, SG2524Bxx and SG3524Bxx device families available in 16L PDIP (.300in) and 16L SOIC (.300in) packages.

Affected Catalog Part Numbers (CPN)

SG3524BN SG3524BDW SG1524BN-12821 SG2524BN SG2524BDW SG2524BDW-TR SG3524BDW-TR